ASSOCIATION CONNECTINI	Material Composit © Copyright 2005. IPC, international and Pan-Ar	Bannockb	urn, Illinois. A	All rights reserved untions.	Inder both le	his docume vel parts, tl	ent is a declarat	ion of the s encompasse	ubstances es all lower	within the manufactu r level materials for w	rer listed	item. Note: i nanufacture	if the item is an as r has engineering	sembly with lower responsibility.	
1752-21.1					Form Type * Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				ials and N	als and Mfg Information				
Supplier Inform	ation														
Company name*			Company unique ID			τ	Unique ID Authority				Respon	Response Date*			
onsemi											2024-05	2024-05-21			
Contact Name			Title - Contact]	Phone - Contact*				Email -	Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative]	Phone - Representative*				Email -	Email - Representative*			
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Requeste	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Date	Version	N	Manufacturing Site		Weight*	UOM	Unit Type	
		NTS260ESFT3G 2A, 60V Low Leak SOD123-FL		akage Trench Rect	ifier in	2024-05-21	MY1			14.9	mg	Each			
Manufacturing	Proccess Information	1													
Terminal Plating / Grid Array Material Termin			rminal Base Alloy J-STD-020 MSL Ra		Rating	Peak Process Body Temperature Max Time at P		e Max Time at Peak	k Temperature Number of Reflow Cycles						
Matte Tin (Sn) - annealed CU Alloy				1		260		С	30	seco	nds 3				
Comments															
level 1 - maximum t	ime at peak temperature o	luring sol	dering is 10-3	0 seconds											
For more information	on regarding material com	position	please refer to	o page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		mium (Cr6+), Polybrominated Biphenyls (Pl		dmium and quantity limit of 0.1% by mass (10 minated Diphenyl Ethers (PBDE), and Bis(2-et					
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in ifies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of				
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted				
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.									
Supplier Digital Signature	astislav Drska	Le							

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select	the Level (IIG A IIG B	Requester or Supplier) [B	l select the subst	ance category (JIG or Requester) or enter a va	alue (Supplier) [C] se	elect the substance (II	G) or enter the substa	nce and CAS (Other) [D]
select a RoHS exemption, if applic	cable [E] enter the weigh	t of the substance or the P	PM concentration	[F] Optionally enter the positive (+) and neg	ative (-) tolerance in	percent (Note: percer	it tolerance values are	expected to cover a 3
sigma range of distribution unless	otherwise noted).							
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	2.02	mg	Supplier	Zinc (Zn)	7440-66-6		0.0024	mg
			Supplier	Iron (Fe)	7439-89-6		0.0475	mg
			Supplier	Copper (Cu)	7440-50-8		1.9695	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0006	mg
Die	0.98	mg	Supplier	Silicon (Si)	7440-21-3		0.98	mg
Die Attach Solder	0.26	mg	Supplier	Silver (Ag)	7440-22-4		0.0065	mg
			А	Lead (Pb)	7439-92-1	7a	0.2405	mg
			Supplier	Tin (Sn)	7440-31-5		0.013	mg
Lead Frame	5.25	mg	Supplier	Zinc (Zn)	7440-66-6		0.0063	mg
			Supplier	Iron (Fe)	7439-89-6		0.1234	mg
			Supplier	Copper (Cu)	7440-50-8		5.1188	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0016	mg
Mold Compound-Black	5.79	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.579	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0289	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.8395	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		3.7635	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.579	mg
Plating	0.6	mg	Supplier	Tin (Sn)	7440-31-5		0.6	mg